Power line chokes

Current-compensated ring core double chokes
250 V AC, 6 … 10 A, 2.8 … 7.8 mH

Series/Type: **B82725S2***

Date: October 2008

Rated voltage 250 V AC
Rated current 6 A to 10 A
Rated inductance 2.8 mH to 7.8 mH

Construction

- Current-compensated ring core double choke
- Ferrite core
- Polycarbonate base plate (UL 94 V-0)
- Choke fixed on base plate with tape
- Sector winding
- Clearance ≥ 2.5 mm, creepage distance ≥ 3 mm

Features

- Approx. 1% stray inductance
  for symmetrical interference suppression
- Suitable for wave soldering
- Design complies with EN 60938-2 (VDE 0565-2)
- RoHS-compatible

Applications

- Suppression of common-mode interferences
- Switch-mode applications

Terminals

- Ends of winding wires
- Hot-dip tinned

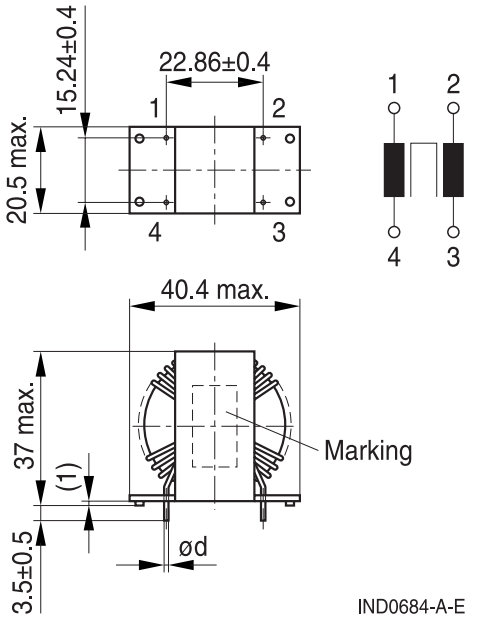
Marking

Manufacturer, ordering code, rated current,
rated voltage, rated inductance,
graphic symbol, date of manufacture (MM.YY)

Delivery mode

Cardboard box

Dimensional drawing and pin configuration



Dimensions in mm

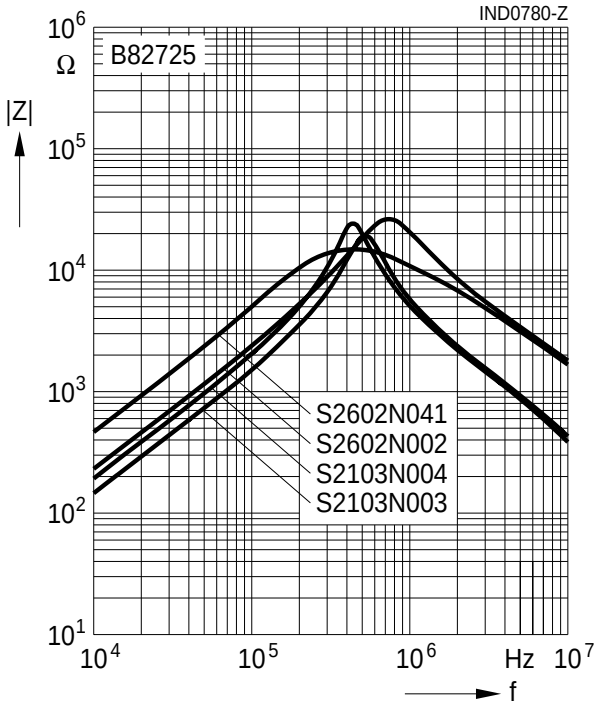
Technical data and measuring conditions

Rated voltage V_R	250 V AC (50/60 Hz)
Test voltage V_{test}	1500 V AC / 2100 V DC, 2 s (line/line)
Rated temperature T_R	60 °C
Rated current I_R	Referred to 50 Hz and rated temperature
Rated inductance L_R	Measured with Agilent 4284A at 10 kHz, 0.1 mA, 20 °C Inductance is specified per winding.
Inductance tolerance	±30% at 20 °C
Inductance decrease $\Delta L/L_0$	< 10% at DC magnetic bias with I_R, 20 °C
Stray inductance $L_{stray,typ}$	Measured with Agilent 4284A at 10 kHz, 5 mA, 20 °C, typical values
DC resistance R_{typ}	Measured at 20 °C, typical values, specified per winding
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: (245 ±5) °C, (3 ±0.3) s Wetting of soldering area ≥ 95% (to IEC 60068-2-20, test Ta)
Resistance to soldering heat (wave soldering)	(260 ±5) °C, (10 ±1) s (to IEC 60068-2-20, test Tb)
Climatic category	40/125/56 (to IEC 60068-1)
Storage conditions (packaged)	–25 °C … +40 °C, ≤ 75% RH
Weight	Approx. 50 g

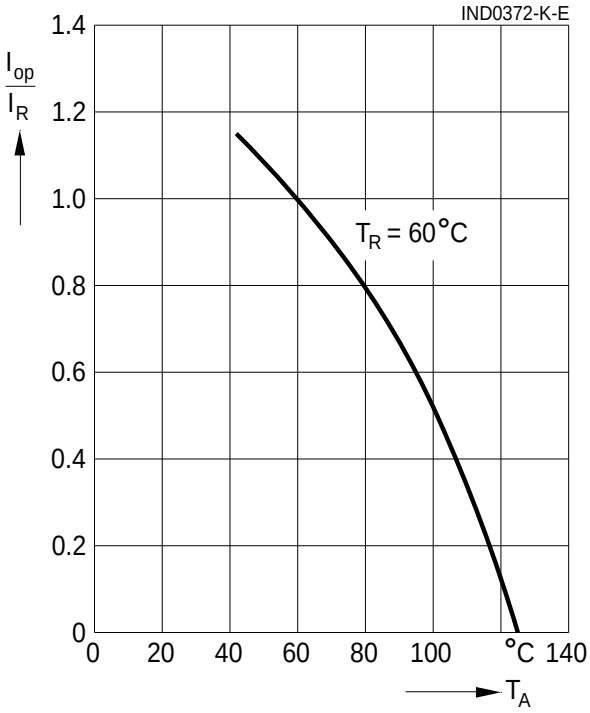
Characteristics and ordering codes

I_R A	L_R mH	$L_{stray,typ}$ µH	R_{typ} mΩ	Wire ∅ d ±0.1 mm	Ordering code
6	7.8	35	24	1.0	B82725S2602N041
6	3.9	33	24	1.0	B82725S2602N002
10	3.3	35	13.5	1.32	B82725S2103N004
10	2.8	30	12.5	1.32	B82725S2103N003

Impedance |Z| versus frequency f
measured with windings in parallel at 20 °C, typical values



Current derating I_{op}/I_R versus ambient temperature T_A



Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.**

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